

Multilayer Ceramic Chip Capacitor

NOVACI	<pre>AP + SYFER + VOLTRONICS</pre>						
Part Number	: 1812YA250102I	KSTSYX	Description:	1812 250Vac (Y2), 305Vac (X1), 50/60Hz / 1000Vdc 1.0nF ±10% X7R (2R1) to AEC- Q200			
Approval	Approval IEC/EN60384-14:2013+A1			~			
Specifications:							
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Certification:	TÜV R60156291 / ID1111	TÜV R60156291 / ID1111239246		Ť			
	UL/cUL E228790-20210208			+ 2			
Classification:	IEC/EN 60384-14:2013+A1 Class Y2 / X1 UL/cUL FOWX2, FOWX8		<	4 - 4 - 13			
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			Component I	Marking and Certification Bodies:			
Material Group I	· CTL>= 600		SYX				
Mechanical Specification							
	Size Code			1812 4.95 ± 0.35 (0.195 ± 0.014)			
Width (W) in mm (")	Length (L1) in mm (")			$3.2 \pm 0.30 (0.126 \pm 0.012)$			
Thickness (T) in mm	(")		1.5 Max (0.06 Max)				
	n Band (L2,L3) in mm (")		0.35 (0.014)				
	n Band (L2,L3) in mm (")		0.80 (0.030)				
Minimum Band Gap (4.0 (0.158)				
Termination Material			FlexiCap [™] Polymer termination, Nickel barrier, Sn Plated Solder				
Solderability			(RoHS compliant) IEC-60068-2-58				
Packaging	-			7" Reel Horizontal Orientation, 500 per reel			
	G	eneral Electri	cal Specificati	on			
Rated Voltage			Class Y2 (250Vac), Class X1 (305Vac), 50/60Hz, 5kV impulse				
Humidity Grade			Grade III (IEC/EN60384-14:2013 Annex 1)				
Maximum DC Working Voltage			1000Vdc certified / (2500Vdc outside scope of any specification)				
Nominal Capacitance Value			1.0nF				
Capacitance Tolerance			±10%				
Tangent of Loss Angle (Tan δ)			≤0.025				
Capacitance and Tan δ Test Conditions			1.0Vrms @ 1kHz				
Voltage Proof			100% test: 4000Vdc 1s min / 5s max				
(50mA max charging current for DC tests)			AQL test: 4000Vdc / 3000Vac 60s min / 5kV 1.2x50µs impulse				
Min Insulation Resistance (IR)		100.00GOhm @ 100Vdc					
			X7R (2R1) to AEC-Q200				
Rated Temperature Range			-55°C / +125°C				
Maximum Capacitance Change over Temperature Range			No DC Voltage Rated DC Voltage	±15% -			
Climatic Category (IEC)			55/125/56	55/125/56			
Ageing Characteristic			<2% per decade				
Knowles Precision Devices Sales							
	pe-sales@knowles.com	This datasheet is for a standard item and is confirmed valid on the date generated, the latest published data for this part may differ and is available at http://www.knowlescapacitors.com or by contacting us.					
Asia: KPD-Asia-sales@knowles.com		ained on this drawing is be copied in whole or part in hird party without the consent programming withing this this					
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www.knowlescapacitors.com of Knowles and a specification.			tomer mentioned within this	Date: Thursday, September 02, 2021 20210902 194158979UTC			



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Environmental								
RoHS Compliant to 2	RoHS Compliant to 2011/65/EC as amended by 2015/863/EU Compliant							
REACH Compliant			211 compliant					
California Proposition 65			No exposure risk					
Board Layout								
Knowles' conventional 2-terminal chip ca generally be mounted using pad designs in acc international specification IPC-7351, Generic for Surface Mount Design and Land Pattern S there are some other factors that have been sho mechanical stress, such as reducing the pad than the chip width. In addition, the position of th board should be considered. Some high voltage parts may require modific board layout and/or the addition of a conform prevent flashover. Refer to application note further information.		n accordance with eric Requirements ern Standards, but n shown to reduce pad width to less of the chip on the odifications to the nformal coating to		IPC-7351 pad design 1812 C 5.35mm Y 1.25mm X 3.40mm 0.134"				
Packaging								
Tape and reel pac	formation for tape-ar king of surface moun matic placement are	ting chip		Product identifying label Plastic carrier tape Top tape 8 or 12mm 178mm (7") or nominal 330mm (13") dia. reel				
Soldering								
Recommended re IPC/JEDEC J-STE Wave soldering is taken for case size thickness >1.0mm Hand soldering is	also possible, but ca es 1210 and larger an . Trials are encourag not recommended ar	own in re must be nd component jed. nd can lead to	Temperature	Time				
component damage through thermal shock.								
Application notes with mounting and handling guidance are available on request.								
Compex	C DLI C	Johanson MFG	Novacap	Syfer Voltronics				
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